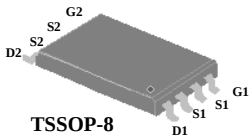
AP9938GEO-HF

Halogen-Free Product

Advanced Power Electronics Corp.

DUAL N-CHANNEL ENHANCEMENT MODE POWER MOSFET

- ▼ **Low on-resistance**
- ▼ **Capable of 1.8V Gate Drive**
- ▼ **Optimal DC/DC Battery Application**
- ▼ **Halogen Free & RoHS Compliant Product**

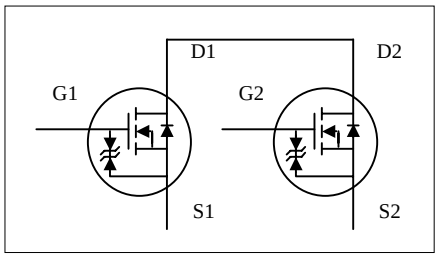


TSSOP-8

BV_{DSS}	20V
$R_{DS(ON)}$	18mΩ
I_D	6A

Description

Advanced Power MOSFETs from APEC provide the designer with the best combination of fast switching, ruggedized device design, ultra low on-resistance and cost-effectiveness.



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	20	V
V_{GS}	Gate-Source Voltage	±8	V
I_D@T_A=25℃	Continuous Drain Current[3]	6	A
I_D@T_A=70℃	Continuous Drain Current[3]	4.8	A
I_{DM}	Pulsed Drain Current[1]	20	A
P_D@T_A=25℃	Total Power Dissipation	1	W
T_{STG}	Storage Temperature Range	-55 to 150	℃
T_J	Operating Junction Temperature Range	-55 to 150	℃

Thermal Data

Symbol	Parameter	Value	Unit
Rthj-a	Maximum Thermal Resistance, Junction-ambient[3]	125	℃/W

Electrical Characteristics@T_j=25°C(unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS}=0V, I_D=250uA	20	-	-	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance[2]	V_{GS}=4.5V, I_D=6A	-	14.9	18	mΩ
		V_{GS}=2.5V, I_D=4A	-	17.2	24	mΩ
		V_{GS}=1.8V, I_D=2A	-	19.9	28	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=V_{GS}, I_D=250uA	0.3	-	1	V
g_{fs}	Forward Transconductance	V_{DS}=5V, I_D=6A	-	28	-	S
I_{DSS}	Drain-Source Leakage Current	V_{DS}=16V, V_{GS}=0V	-	-	10	uA
I_{GSS}	Gate-Source Leakage	V_{GS}=±8V, V_{DS}=0V	-	-	±30	uA
Q_g	Total Gate Charge	I_D=6A	-	16	26	nC
Q_{gs}	Gate-Source Charge	V_{DS}=10V	-	1.6	-	nC
Q_{gd}	Gate-Drain ("Miller") Charge	V_{GS}=4.5V	-	4.3	-	nC
$t_{d(on)}$	Turn-on Delay Time	V_{DS}=10V	-	7	-	ns
t_r	Rise Time	I_D=1A	-	11	-	ns
$t_{d(off)}$	Turn-off Delay Time	R_G=3.3Ω	-	31	-	ns
t_f	Fall Time	V_{GS}=5V	-	6	-	ns
C_{iss}	Input Capacitance	V_{GS}=0V	-	1070	1710	pF
C_{oss}	Output Capacitance	V_{DS}=10V	-	130	-	pF
C_{rss}	Reverse Transfer Capacitance	f=1.0MHz	-	115	-	pF
R_g	Gate Resistance	f=1.0MHz	-	1.4	2.8	Ω

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_{SD}	Forward On Voltage[2]	I_S=1.2A, V_{GS}=0V	-	-	1.2	V
t_{rr}	Reverse Recovery Time	I_S=6A, V_{GS}=0V,	-	14	-	ns
Q_{rr}	Reverse Recovery Charge	dI/dt=100A/μs	-	4	-	nC

Notes:

1.Pulse width limited by Max. junction temperature.

2.Pulse test

3.Surface mounted on 1 in^2 copper pad of FR4 board ; 208℃/W when mounted on Min. copper pad.

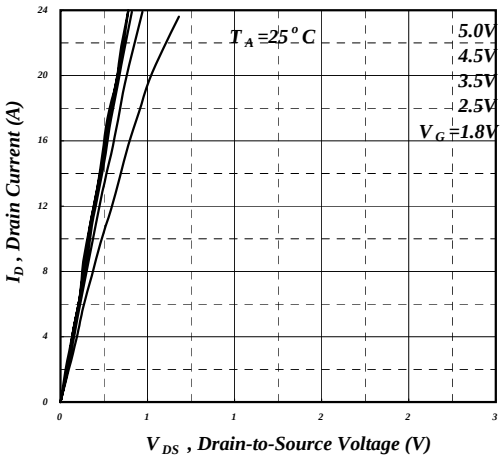


Fig 1. Typical Output Characteristics

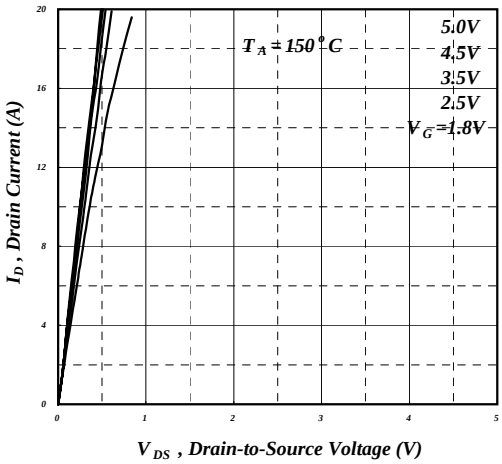


Fig 2. Typical Output Characteristics

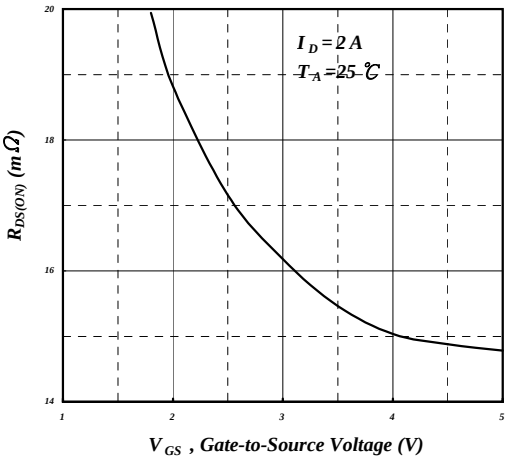


Fig 3. On-Resistance v.s. Gate Voltage

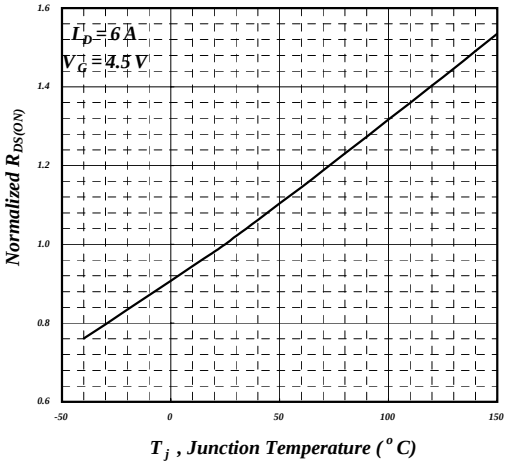


Fig 4. Normalized On-Resistance v.s. Junction Temperature

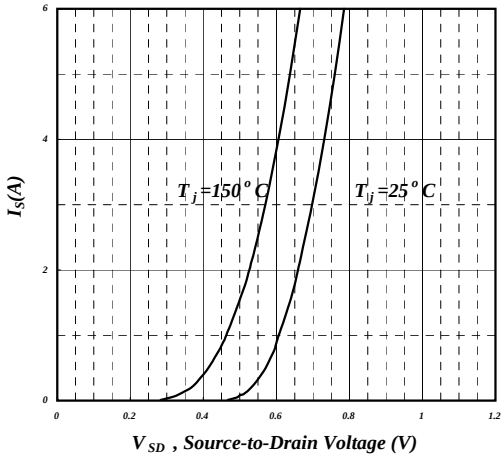


Fig 5. Forward Characteristic of Reverse Diode

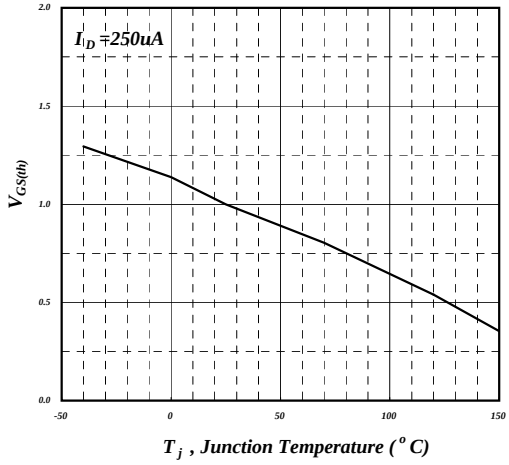


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

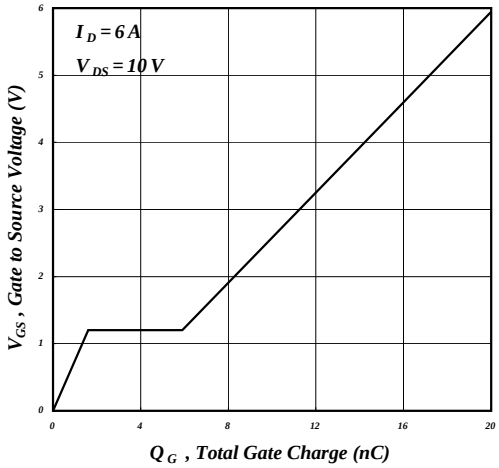


Fig 7. Gate Charge Characteristics

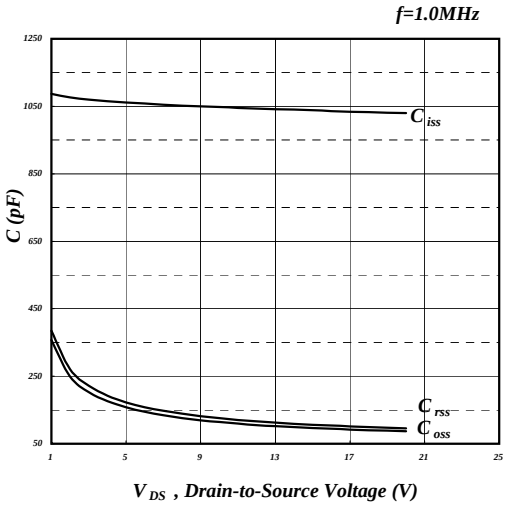


Fig 8. Typical Capacitance Characteristics

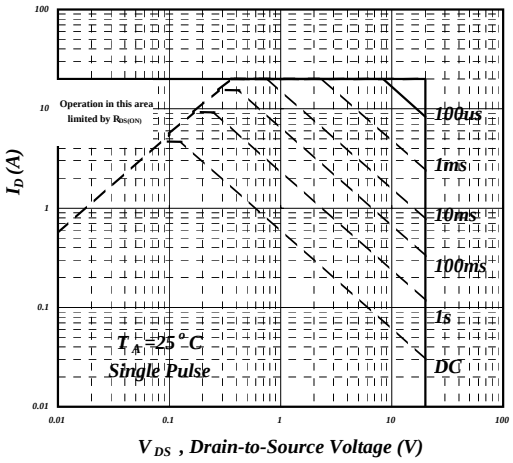


Fig 9. Maximum Safe Operating Area

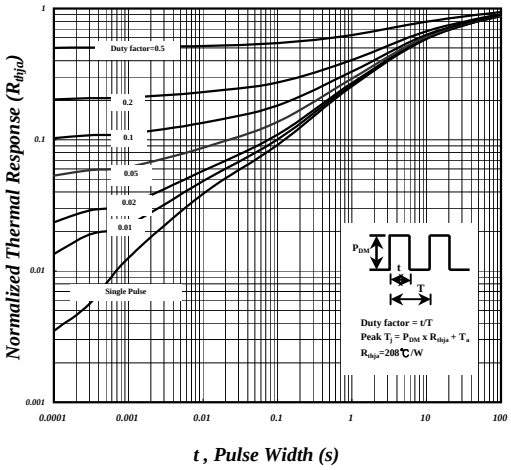


Fig 10. Effective Transient Thermal Impedance

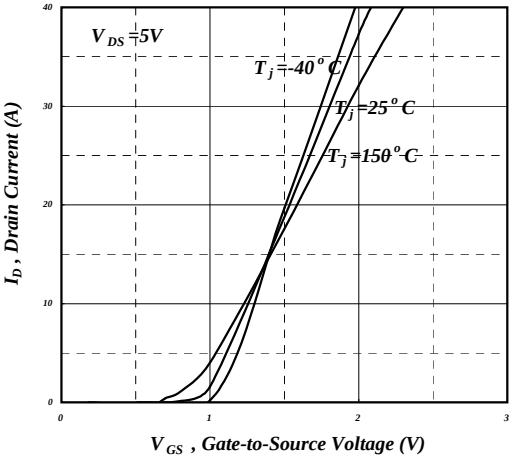


Fig 11. Transfer Characteristics

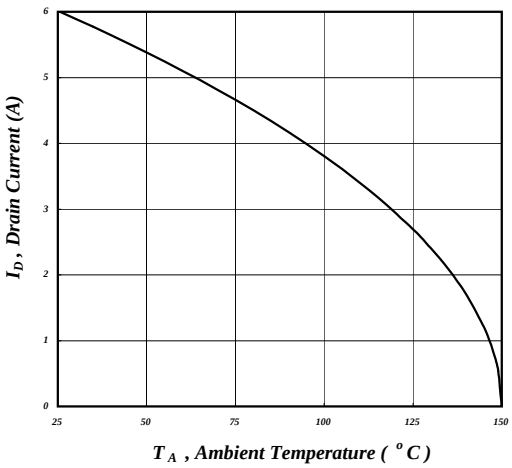


Fig 12. Maximum Continuous Drain Current v.s. Ambient Temperature

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